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SPECIFICATION

COSTONI							
MODULE	E NO.: _	WG12864I-YGH-V#N					
APPROV:)					
			ERSION:	DATA:			
SALES BY	APPROVE	D BY	CHECKED B	BY PREPARED BY			



REC	ORDS OF REV	ISION	DO	OC. FIRST ISSUE				
VERSION	DATE	REVISED PAGE NO.	SUMN	MARY				
0	2006-11-20		First issue					

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1. Module Classification Information

 $\underline{\mathbf{W}}$ $\underline{\mathbf{G}}$ $\underline{I} - \underline{Y} \underline{G} \underline{H} -$ 12864 V#N 1) (2) 3 4 5 6 7 8

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type

3 Display Font: 128 * 64 Dots

Model serials no.

S Backlight Type : N→Without backlight T→LED, White

> B→EL, Blue green A→LED, Amber

D→EL, Green $R\rightarrow LED$, Red

W→EL, White O→LED, Orange

F→CCFL, White G→LED, Green

Y→LED, Yellow Green

© LCD Mode : B→TN Positive, Gray T→FSTN Negative

N→TN Negative,

G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

② LCD Polarizer Type/ A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Temperature range/ D→Reflective, N.T, 12:00 View direction

G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

K→Transflectiv, W.T,12:00

 $F \rightarrow Transmissive, N.T, 12:00$

I→Transmissive, W. T, 6:00

J→Reflective, W. T, 12:00

E→Transflective, N.T.12:00 L→Transmissive, W.T, 12:00

Special Code V : Negative Voltage generator on board

#:Fit in with the ROHS Directions and regulations

N: IC NT7107,NT7108

B→Transflective, N.T,6:00

2.Precautions in Use of LCD Module

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD Module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering:only to the I/O terminals.
- (7)Storage:pleasse storage in anti-static electricity container and clean environment.

3.General Specification

ITEM	STANDARD VALUE	UNIT					
Number of dots	128 ×64	dots					
Module dimension	80.0(W) ×70.0(H) ×13.6(T)	mm					
View area	72.0(W) ×40.0(H)	mm					
Active area	66.52(W) ×33.24(H)	mm					
Dot size	$0.48(W) \times 0.48(H)$	mm					
Dot pitch	$0.52(W) \times 0.52(H)$	mm					
LCD type	STN Positive, Gray, Transflective						
View direction	6 o'clock						
Backlight	LED, yellow green						

4.Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNNIT
Operating Temperature	T_{OP}	-20	_	+70	${\mathbb C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	V _I	0	_	V_{CC}	V
Supply Voltage For Logic	V_{DD}	0	_	6.7	V
Supply Voltage For LCD	V_{DD} - V_{LCD}	0	_	16.7	V
Supply Voltage For LCD	V _{OUT}	_	_	-5	V

5.Electrical Characteristics

ITEM	SSYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	$V_{\text{DD}}\text{-}V_{\text{SS}}$	_	4.5	5.0	5.5	V
		Ta=-20°C	_	_	10.5	V
Supply Voltage For LCI	V_{DD} - V_0	Ta=25°C	_	8.7	_	V
		Ta=+70°C	7.6	_	_	V
Input High Vol	$V_{ m IH}$	_	2.0	_	V_{DD}	V
Input Low Vol	$ m V_{IL}$	_	0	_	0.8	V
Output High Vol	V_{OH}	_	2.4	_	V_{DD}	V
Output Low Vol.	V_{OL}	_	0	_	0.4	V
Supply Current	$I_{ m DD}$	_	3.0	4.0	5.0	mA

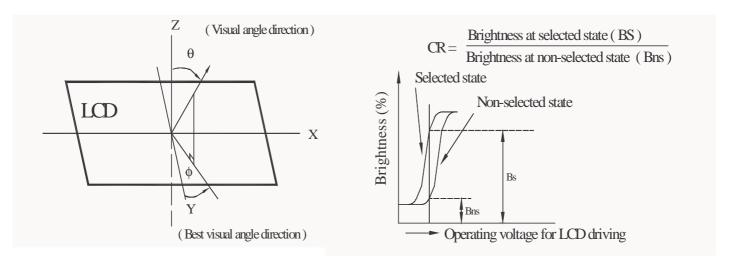
6.Optical Characteristics

ITEM	SYMBAL	CONDITION	MIN	TYP	MAX	UNIT
	(V) θ	CR≧2	20	_	40	deg.
View Angle	(H) φ	CR≧2	-30	_	30	deg.
Contrast Ratio	CR	_	_	3		_
	T rise	_	_	200	300	ms
Response Time	T fall	_	_	200	300	ms

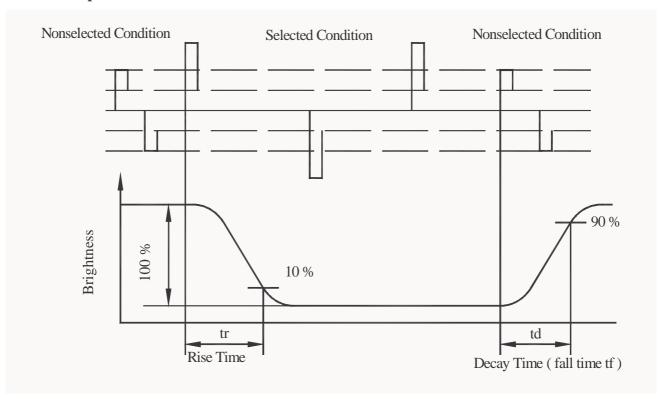
6.1 Definitions

■ View Angles

■Contrast Ratio



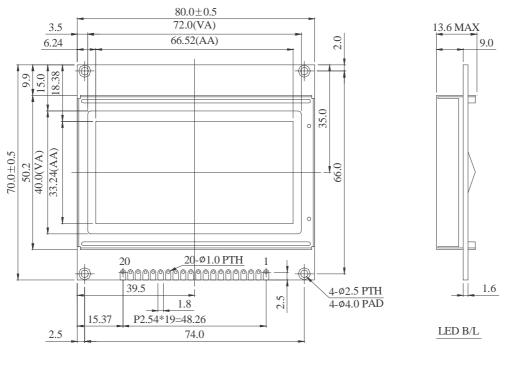
■Response time

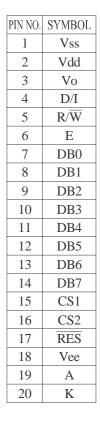


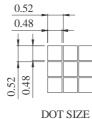
7.Interface Pin Function

Pin No.	Symbol	Level	Description
1	VSS	0V	Ground
2	V_{DD}	5.0V	Supply voltage for logic
3	Vo	(Variable)	Contrast Adjustment
4	D/I	H/L	H: Data , L: Instruction
5	R/W	H/L	H: Read(MPU←Module) , L :Write(MPU→Module)
6	Е	Н	Enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line
15	CS1	Н	Select Column 1 ~ Column 64
16	CS2	Н	Select Column 65 ~ Column 128
17	RST	L	Reset signal
18	Vout		Negative Voltage
19	A	_	Power supply for LED backlight (+)
20	K	_	Power supply for LED backlight (-)

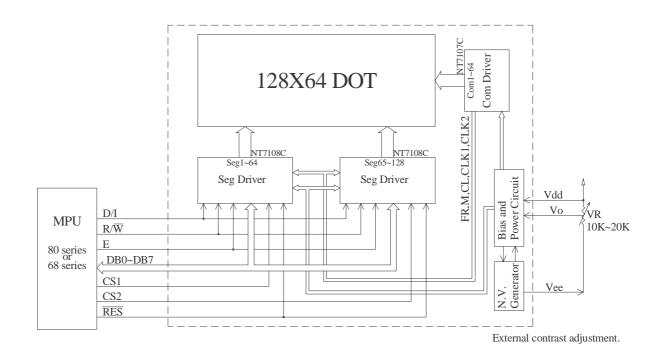
8.Contour Drawing & Block Diagram







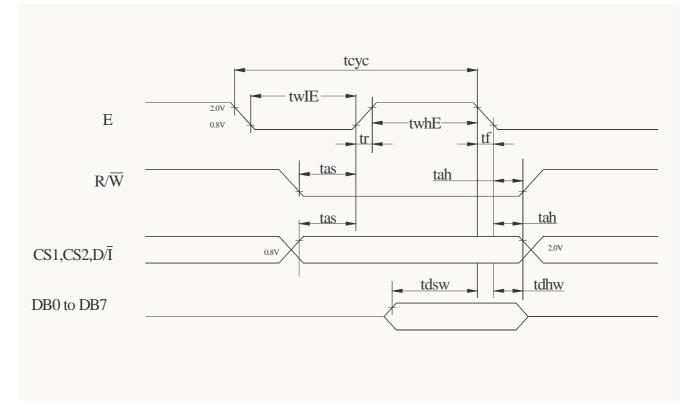
The non-specified tolerance of dimension is ± 0.3 mm.



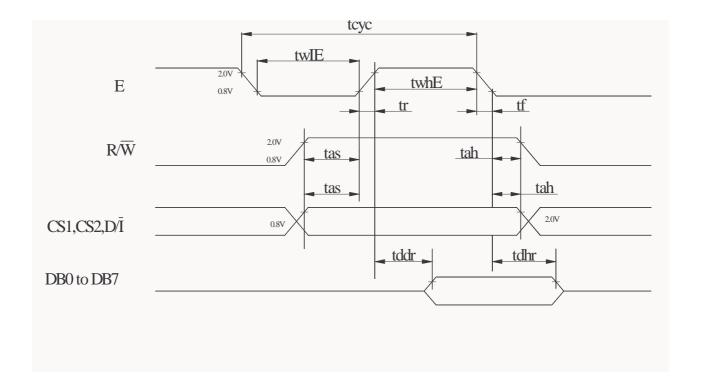
9.Timing Characteristics

MPU Interface

Characteristic	Symbol	Min	Тур	Max	Unit
E cycle	tcyc	1000	_	_	ns
E high level width	twhE	450	_	_	ns
E low level width	twlE	450	_	_	ns
E rise time	tr		_	25	ns
E tall time	tf		_	25	ns
Address set-up time	tas	140	_	_	ns
Address hold time	tah	10	_	_	ns
Data set-up time	tdsw	200	_	_	ns
Data delay time	tddr		_	320	ns
Data hold time (write)	tdhw	10	_	_	ns
Data hold time (read)	tdhr	20	_	_	ns



MPU Write Timing



MPU Read Timing

10. Display Control Instruction

The display control instructions control the internal state of the NT7108. Instruction is received from MPU to NT7108 for the display control. The following table shows various instructions.

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display on/off	L	L	L	L	Н	Н	Н	Н	Н	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L:OFF, H:ON
Set address (Y address)	L	L	L	Н	Y address (0-63)				3)		Sets the Y address in the Y address counter.
Set page (X address)	L	L	Н	L	H H H Page (0-7)				age (0	-7)	Sets the X address at the X address register.
Display Start line (Z address)	L	L	Н	Н		Display start line (0-63)					Indicates the display data RAM displayed at the top of the screen.
Status read	L	Н	Busy	L	On/ Off	Reset	L	L	L	L	Read status. BUSY L: Ready H: In operation ON/OFF L: Display ON H: Display OFF RESET L: Normal H: Reset
Write display data	Н	L				Write data					Writes data (DB0: 7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read display data	Н	Н				Read data					Reads data (DB0: 7) from display data RAM to the data bus.

11.Detailed Explanation

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	0	1	1	1	1	1	D

The display data appears when D is 1 and disappears when D is 0. Though the data is not on the

screen with D=0, it remains in the display data RAM. Therefore, you can make it appear by changing D=0 into D=1.

SET ADDRESS (Y ADDRESS)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

Y address (AC0-AC5) of the display data RAM is set in the Y address counter. An address is set by instruction and increased by 1 automatically by read or write operations of display data.

SET PAGE (X ADDRESS)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	0	1	1	1	AC2	AC1	AC0

X address (AC0-AC2) of the display data RAM is set in the X address register. Writing or reading to or from MPU is executed in this specified page until the next page is set.

DISPLAY START LINE (Z ADDRESS)

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	0	1	1	AC5	AC4	AC3	AC2	AC1	AC0

Z address (AC0-AC5) of the display data RAM is set in the display start line register and displayed at the top of the screen. When the display duty cycle is 1/64 or others (1/32-1/64), the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed.

STATUS READ

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
0	1	BUSY	0	ON/OFF	RESET	0	0	0	0

· BUSY

When BUSY is 1, the Chip is executing internal operation and no instructions are accepted.

When BUSY is 0, the Chip is ready to accept any instructions.

· ON/OFF

When ON/OFF is 1, the display is OFF.

When ON/OFF is 0, the display is ON.

· RESET

When RESET is 1, the system is being initialized.

In this condition, no instructions except status read can be accepted.

When RESET is 0, initializing has finished and the system is in usual operation condition.

WRITE DISPLAY DATA

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	0	D7	D6	D5	D4	D3	D2	D1	D0

Writes data (D0-D7) into the display data RAM. After writing instruction, Y address is increased by 1automatically.

READ DISPLAY DATA

RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
1	1	D7	D6	D5	D4	D3	D2	D1	D0

Reads data (D0-D7) from the display data RAM. After reading instruction, Y address is increased by 1 automatically.

12.RELIABILITY

Content of Reliability Test (wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation $ -20^{\circ}\text{C} \qquad 25^{\circ}\text{C} \qquad 70^{\circ}\text{C} $	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k Ω CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.

13. Backlight Information

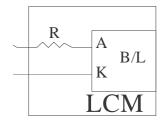
Specification

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	260	330	480	mA	V=4.2V
Supply Voltage	V	4.0	4.2	4.4	V	_
Reverse Voltage	VR	_	_	10	V	_
Luminous Intensity	IV	150	186.6	_	CD/M ²	ILED=330mA
Wave Length	λρ	560	570	580	nm	ILED=330mA
Life Time	-	_	100000	_	Hr.	ILED=330mA
Color Yellow Green				1		

Note: The LED of B/L is drive by current only, drive voltage is for reference only.

drive voltage can make driving current under safety area (current between minimum and maximum).

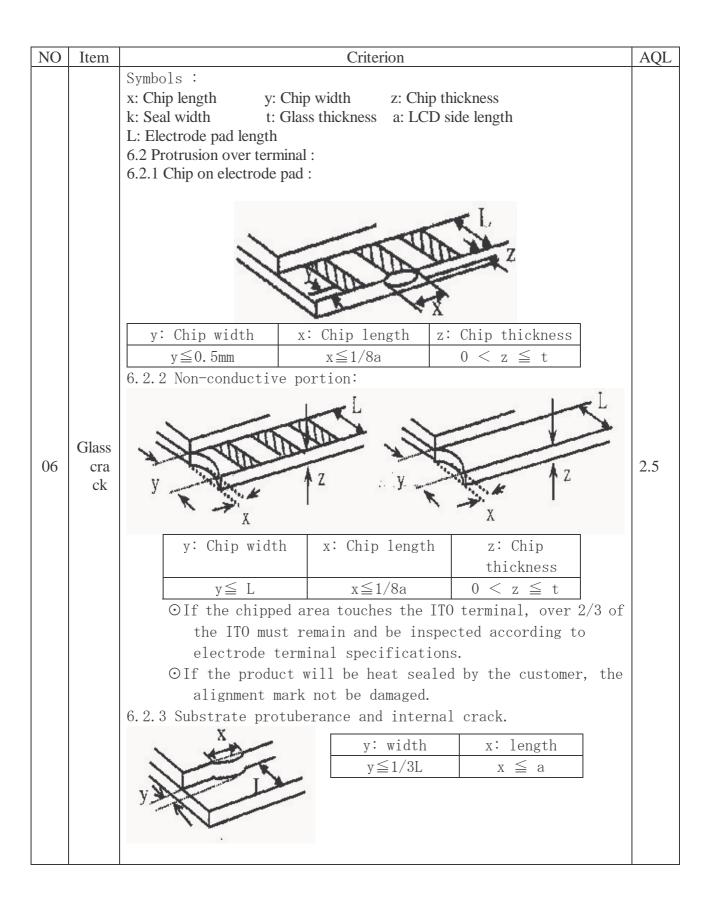
.Drive from pin19,pin20



14. <u>Inspection specification</u>

NO	Item			Criterion		AQL		
01	Electrical Testing	1.2 Missing char 1.3 Display malf 1.4 No function 1.5 Current cons 1.6 LCD viewing 1.7 Mixed produ	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 					
02	Black or white spots on LCD (display only)	 2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm 						
03	LCD black spots, white spots, contaminatio n (non-display	3.1 Round type: $\Phi = (x + \frac{X}{2})$ 3.2 Line type: (A)	y) / 2 ↓ Y	SIZE $ \Phi \le 0.10 $ 0.10 < $ \Phi \le 0.20 $ 0.20 < $ \Phi \le 0.25 $ 0.25 < Φ	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Accept no dense 2 As round type	2.5		
04	Polarizer bubbles	If bubbles are vis judge using bla specifications, to find, must c specify direction	nck spot not easy heck in	Size Φ $\Phi \le 0.2$ 0 0.20 < $\Phi \le 0.50$ 0.50 < $\Phi \le 1.00$ 1.00 < Φ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5		

NO	Item	Criterion	AQL
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination	
06	Chipped glass	Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length: 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels: z: Chip thickness y: Chip width x: Chip length Z≤1/2t Not over viewing x≤1/8a area 1/2t <z≤2t 1="" 2="" 3k="" 6.1.2="" 8a="" are="" chip="" chip.="" chip.<="" chips,="" corner="" crack:="" each="" exceed="" is="" length="" more="" not="" of="" olf="" or="" td="" there="" thickness="" total="" width="" x="" x:="" x≤1="" y:="" z:=""><td>2.5</td></z≤2t>	2.5
		Z≦1/2t Not over viewing x≦1/8a	
		area $1/2t < z \le 2t \qquad \text{Not exceed } 1/3k \qquad x \le 1/8a$	
		$0 = 1/2t < z \ge 2t$ Not exceed $1/3k$ $x \ge 1/8a$ $0 = 1/3k$ $0 = 1/3k$	
		chip.	
		onip.	



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10. 1 COB seal may not have pinholes larger than 0. 2mm or contamination. 10. 2 COB seal surface may not have pinholes through to the IC. 10. 3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10. 9 The Scraping testing standard for Copper Coating of PCB 	2.5 2.5 0.65 2.5 2.5 0.65 2.5 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

15. Material List of Components for RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

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Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs	
Limited	100	1000	1000	1000	1000	1000	
Value	ppm	ppm	ppm	ppm	ppm	ppm	
Above limited value is set up according to RoHS.							

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250, 30 seconds Max.;

2. Process for RoHS requirement:

Connector soldering wave or hand soldering: 320, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5 ;

Recommended customer's soldering temp. of connector: 280, 3 seconds.



Mo	dule Number:			Page: 1
1, Pa	anel Specification:			
1.	Panel Type:	☐ Pass	□ NG ,	
2.	View Direction:	☐ Pass	□ NG ,	
3.	Numbers of Dots:	□ Pass	□ NG ,	
4.	View Area:	☐ Pass	□ NG ,	
5.	Active Area:	☐ Pass	□ NG ,	
6.	Operating Temperature:	☐ Pass	□ NG ,	
7.	Storage Temperature:	☐ Pass	□ NG ,	
8.	Others:			
2、 <u>M</u>	Techanical Specification :			
1.	PCB Size:	☐ Pass	□ NG ,	
2.	Frame Size:	□ Pass	□ NG ,	
3.	Materal of Frame:	□ Pass	□ NG ,	
4.	Connector Position:	□ Pass	□ NG ,	
5.	Fix Hole Position:	□ Pass	□ NG ,	
6.	Backlight Position:	□ Pass	□ NG ,	
7.	Thickness of PCB:	□ Pass	□ NG ,	
8.	Height of Frame to PCB:	□ Pass	□ NG ,	
9.	Height of Module:	□ Pass		
10.	Others:	□ Pass	□ NG ,	
3、 <u>R</u>	elative Hole Size :			
1.	Pitch of Connector:	□ Pass	□ NG ,	
2.	Hole size of Connector:	□ Pass	□ NG ,	
3.	Mounting Hole size:	□ Pass	□ NG ,	
4.	Mounting Hole Type:	□ Pass		
5.	Others:	□ Pass	□ NG ,	
4、 <u>B</u> a	acklight Specification:			
1.	B/L Type:	□ Pass	□ NG ,	
2.	B/L Color:	□ Pass	□ NG ,	
3.	B/L Driving Voltage (Refere	ence for LED T	Type): □ Pass	□ NG ,
4.	B/L Driving Current:	□ Pass	□ NG ,	
5.	Brightness of B/L:	□ Pass		
6.	B/L Solder Method:	□ Pass		

7.	Others:	☐ Pass	□ NG ,		
>> Go to page 2 <<					
winstar					
Module Number :				Page: 2	
5、 <u>E</u>	Electronic Characteristics of N	<u>Iodule</u> :			
1.	Input Voltage:	☐ Pass	□ NG ,		
2.	Supply Current:	☐ Pass	\square NG,		
3.	Driving Voltage for LCD:	☐ Pass	\square NG,		
4.	Contrast for LCD:	☐ Pass	□ NG ,		
5.	B/L Driving Method:	☐ Pass	□ NG ,		
6.	Negative Voltage Output:	☐ Pass	□ NG ,		
7.	Interface Function:	☐ Pass	□ NG ,		
8.	LCD Uniformity:	☐ Pass	□ NG ,		
9.	ESD test:	☐ Pass	□ NG ,		
10.	Others:	☐ Pass			
6. Summary:					
	Sales signature :				
	Customer Signature :	Date:	/ /		